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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE: NATURE OF CONVEYANCE:		NEW ASSIGNMENT				
		ASSIGNMENT				
CONVEYING PARTY	/ DATA	·				
		Name	Execution Date			
DIETER SCHMALST	IEG		04/20/2014			
GERHARD REITMA	04/29/2014					
THANH QUOC NGU	YEN		04/18/2014			
RAPHAEL DAVID AN	04/29/2014					
TOBIAS MARTIN LANGLOTZ			04/22/2014			
HARTMUT SEICHTER			04/29/2014			
		QUALCOMM Incorporated				
		COMM Incorporated				
Name:	QUAL	COMM Incorporated Iorehouse Drive				
RECEIVING PARTY Name: Street Address: City:	QUAL	lorehouse Drive				
Name: Street Address: City:	QUAL0	lorehouse Drive ego				
Name: Street Address:	QUALC 5775 M San Di	lorehouse Drive ego				
Name: Street Address: City: State/Country: Postal Code:	QUALO 5775 N San Di CALIFO 92121	lorehouse Drive ego DRNIA				
Name: Street Address: City: State/Country:	QUALO 5775 M San Di CALIFO 92121 RS Total: 2	lorehouse Drive ego DRNIA				
Name: Street Address: City: State/Country: Postal Code: PROPERTY NUMBE	QUALC 5775 M San Di CALIFC 92121 RS Total: 2 pe	lorehouse Drive ego DRNIA				

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.

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Correspondent Name:	KILPATRICK TOWNSEND & STOCKTON LLP			
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Address Line 2:	EIGH	IT FLOOR		
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ATTORNEY DOCKET NUMBER:		134609 (887066)		
NAME OF SUBMITTER:		ADIL KARRAR		
SIGNATURE:		/Adil Karrar/		
DATE SIGNED:		05/07/2014		

Total Attachments: 3	
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ASSIGNMENT

WHEREAS, WE,

1. **Dieter Schmalstieg**, a citizen of Austria, having a mailing address located at Ursprungweg 146, Graz, Austria 8045 and a resident of Graz, Austria.

2. Gerhard Reitmayr, a citizen of Austria, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of Vienna, Austria.

3. Thanh Quoc Nguyen, a citizen of Vietnam, having a mailing address located at Petersgasse 86/21, Graz, Austria 8010 and a resident of Graz, Austria.

4. **Raphael David Andre Grasset**, a citizen of France, having a mailing address located at Humboldtstrasse 12, Graz, Austria 8010 and a resident of Graz, Austria.

5. **Tobias Martin Langlotz**, a citizen of Germany, having a mailing address located at Humboldtstrasse 12, Graz, Austria 8010 and a resident of Graz, Austria.

6. Hartmut Seichter, a citizen of Germany, having a mailing address located at Strassganger Strasse 1b/23, Graz, Austria 8020 and a resident of Graz, Austria.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **STRUCTURAL MODELING USING DEPTH SENSORS** (collectively the "**INVENTIONS**") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 14/250,544 filed April 11, 2014, Qualcomm Reference No. 134609, and all provisional applications relating thereto, together with U.S. Provisional Application No. 61/876,421, filed September 11, 2013, Qualcomm Reference No. 134609P1, (and do hereby authorize ASSIGNEE and its representative to

hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

PATENT

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Done at _____, on ____, April 20 2014 **Dieter Schmalstieg** Done at Vienna, on April 29 2014 LOCATION DATE **Gerhard Reitmayr** Done at Graz, Austria, on April 18,2014 Thanh Quoc Nguyen Done at <u>LOCATION</u>, on <u>April 2</u>, 2014 Raphael David Andre Grasset Done at Dunedin , on April 22, 2014 Toblas Martin Langlotz LOCATION DATE Done at <u>GRAZ</u>, on <u>22 2014</u> LOCATION DATE lartinut Seichter

RECORDED: 05/07/2014